

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Apurva Kumar	11/06/2006
RECEIVING PARTY DATA	
Name:	International Business Machines Corporation
Street Address:	New Orchard Road
City:	Armonk
State/Country:	NEW YORK
Postal Code:	10504
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11567803
CORRESPONDENCE DATA	
Fax Number:	(301)261-8825
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	410-573-1545
Email:	baumann@gibbiplaw.com
Correspondent Name:	Gibb I.P. Law Firm, LLC
Address Line 1:	2568-A Riva Road
Address Line 2:	Suite 304
Address Line 4:	Annapolis, MARYLAND 21401
ATTORNEY DOCKET NUMBER:	IN920050041US1
NAME OF SUBMITTER:	Frederick W. Gibb, III
Total Attachments: 1 source=Assignment#page1.tif	

CH \$40.00 11567803

IBM Docket No IN920050041US1

ASSIGNMENT

Whereas, I/We,

Apurva Kumar

of E-31, Site 2 Indian Oil Nagar, Sector 55, NOIDA 201301, India

have invented certain improvements in:

Distributed Directory with Proxy

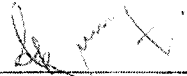
and executed a United States patent application therefor on even date

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM) desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I/We the above named, hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and I/We request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to IBM, its successors and assigns; and I hereby agree that IBM may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

Signed and sealed

Inventor's Signature:



Apurva Kumar

Date:

November 6, 2006